

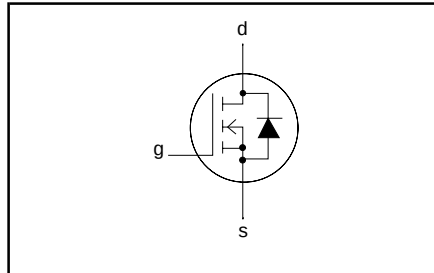
PowerMOS transistors Avalanche energy rated

PHW14N50E

FEATURES

- Repetitive Avalanche Rated
- Fast switching
- Stable off-state characteristics
- High thermal cycling performance
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

$$V_{DSS} = 500 \text{ V}$$

$$I_D = 14 \text{ A}$$

$$R_{DS(ON)} \leq 0.4 \Omega$$

GENERAL DESCRIPTION

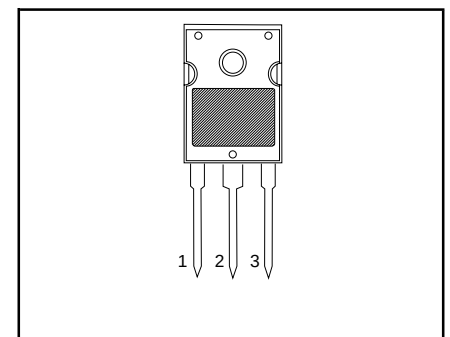
N-channel, enhancement mode field-effect power transistor, intended for use in off-line switched mode power supplies, T.V. and computer monitor power supplies, d.c. to d.c. converters, motor control circuits and general purpose switching applications.

The PHW14N50E is supplied in the SOT429 (TO247) conventional leaded package.

PINNING

PIN	DESCRIPTION
1	gate
2	drain
3	source
tab	drain

SOT429 (TO247)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DSS}	Drain-source voltage	$T_j = 25^\circ\text{C}$ to 150°C	-	500	V
V_{DGR}	Drain-gate voltage	$T_j = 25^\circ\text{C}$ to 150°C ; $R_{GS} = 20 \text{ k}\Omega$	-	500	V
V_{GS}	Gate-source voltage		-	± 30	V
I_D	Continuous drain current	$T_{mb} = 25^\circ\text{C}$; $V_{GS} = 10 \text{ V}$	-	14	A
		$T_{mb} = 100^\circ\text{C}$; $V_{GS} = 10 \text{ V}$	-	9	A
I_{DM}	Pulsed drain current	$T_{mb} = 25^\circ\text{C}$	-	56	A
P_D	Total dissipation	$T_{mb} = 25^\circ\text{C}$	-	192	W
T_j, T_{stg}	Operating junction and storage temperature range		- 55	150	$^\circ\text{C}$

AVALANCHE ENERGY LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E_{AS}	Non-repetitive avalanche energy	Unclamped inductive load, $I_{AS} = 14 \text{ A}$; $t_p = 0.2 \text{ ms}$; T_j prior to avalanche = 25°C ; $V_{DD} \leq 50 \text{ V}$; $R_{GS} = 50 \Omega$; $V_{GS} = 10 \text{ V}$	-	920	mJ
E_{AR}	Repetitive avalanche energy ¹	$I_{AR} = 14 \text{ A}$; $t_p = 2.5 \mu\text{s}$; T_j prior to avalanche = 25°C ; $R_{GS} = 50 \Omega$; $V_{GS} = 10 \text{ V}$	-	23	mJ
I_{AS}, I_{AR}	Repetitive and non-repetitive avalanche current		-	14	A

¹ pulse width and repetition rate limited by T_j max.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base	in free air	-	-	0.65	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient		-	45	-	K/W

ELECTRICAL CHARACTERISTICS

 $T_j = 25\ ^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 0.25\text{ mA}$	500	-	-	V
$\Delta V_{(BR)DSS} / \Delta T_j$	Drain-source breakdown voltage temperature coefficient	$V_{DS} = V_{GS}; I_D = 0.25\text{ mA}$	-	0.1	-	%/K
$R_{DS(ON)}$	Drain-source on resistance	$V_{GS} = 10\text{ V}; I_D = 7\text{ A}$	-	0.33	0.4	Ω
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 0.25\text{ mA}$	2.0	3.0	4.0	V
g_{fs}	Forward transconductance	$V_{DS} = 30\text{ V}; I_D = 7\text{ A}$	5	9.5	-	S
I_{DSS}	Drain-source leakage current	$V_{DS} = 500\text{ V}; V_{GS} = 0\text{ V}$	-	0.2	20	μA
I_{GSS}	Gate-source leakage current	$V_{DS} = 400\text{ V}; V_{GS} = 0\text{ V}; T_j = 125\ ^\circ\text{C}$	-	250	500	μA
		$V_{GS} = \pm 30\text{ V}; V_{DS} = 0\text{ V}$	-	10	200	nA
$Q_{g(tot)}$	Total gate charge	$I_D = 14\text{ A}; V_{DD} = 400\text{ V}; V_{GS} = 10\text{ V}$	-	110	150	nC
Q_{gs}	Gate-source charge		-	9	12	nC
Q_{gd}	Gate-drain (Miller) charge		-	53	60	nC
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 250\text{ V}; R_D = 18\ \Omega;$ $R_G = 4.7\ \Omega$	-	16	-	ns
t_r	Turn-on rise time		-	54	-	ns
$t_{d(off)}$	Turn-off delay time		-	110	-	ns
t_f	Turn-off fall time		-	53	-	ns
L_d	Internal drain inductance	Measured from tab to centre of die	-	3.5	-	nH
L_d	Internal drain inductance	Measured from drain lead to centre of die	-	4.5	-	nH
L_s	Internal source inductance	Measured from source lead to source bond pad	-	7.5	-	nH
C_{iss}	Input capacitance	$V_{GS} = 0\text{ V}; V_{DS} = 25\text{ V}; f = 1\text{ MHz}$	-	1700	-	pF
C_{oss}	Output capacitance		-	250	-	pF
C_{rss}	Feedback capacitance		-	140	-	pF

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

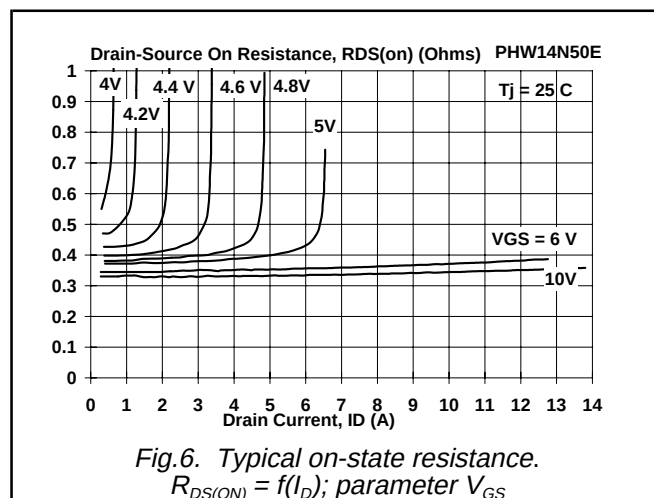
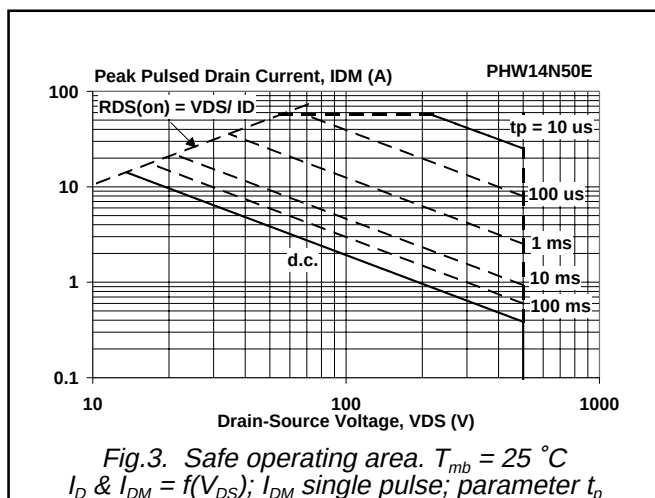
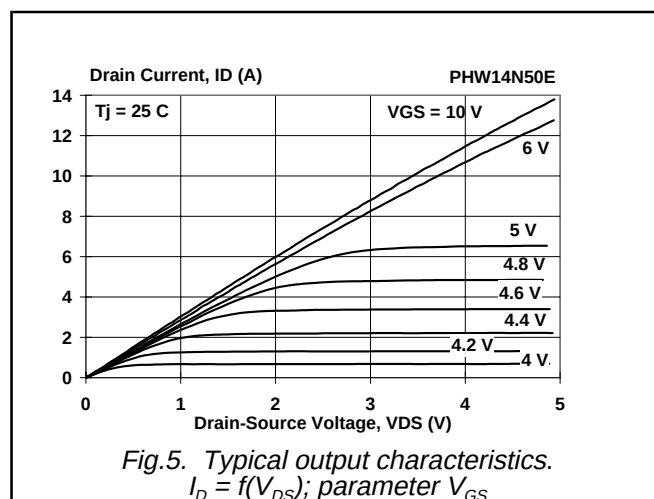
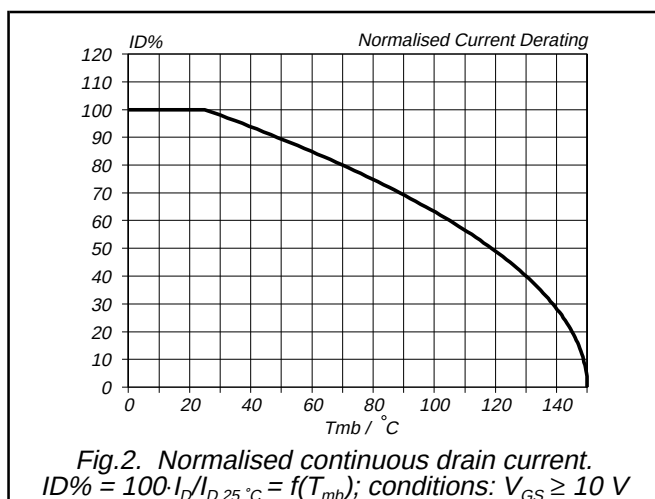
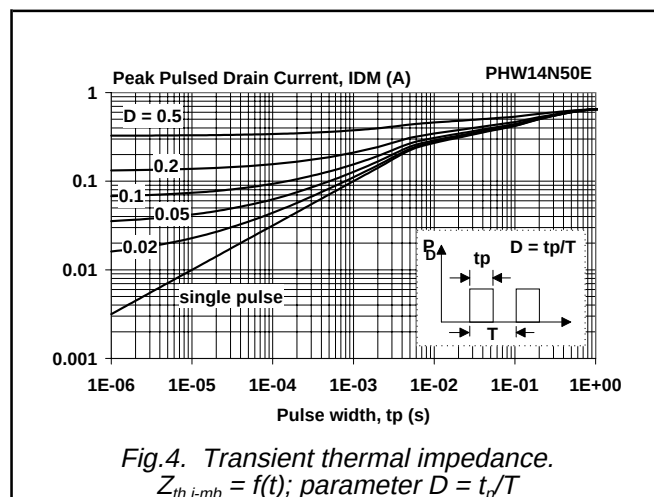
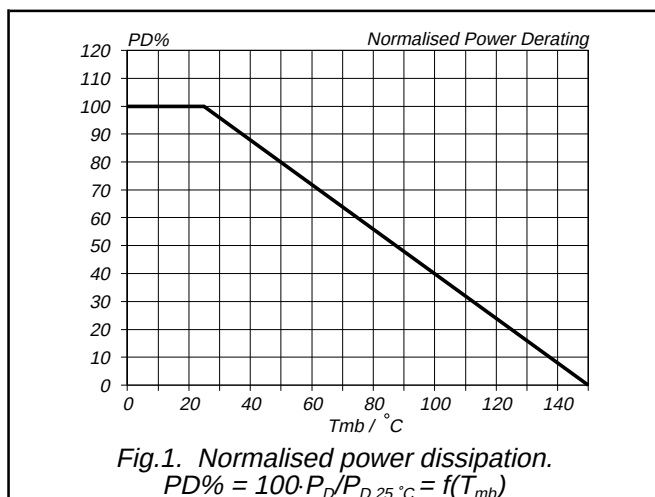
 $T_j = 25\ ^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_S	Continuous source current (body diode)	$T_{mb} = 25\ ^\circ\text{C}$	-	-	14	A
I_{SM}	Pulsed source current (body diode)	$T_{mb} = 25\ ^\circ\text{C}$	-	-	56	A
V_{SD}	Diode forward voltage	$I_S = 14\text{ A}; V_{GS} = 0\text{ V}$	-	0.99	1.5	V
t_{rr}	Reverse recovery time	$I_S = 14\text{ A}; V_{GS} = 0\text{ V}; dI/dt = 100\text{ A}/\mu\text{s}$	-	600	-	ns
Q_{rr}	Reverse recovery charge		-	10	-	μC

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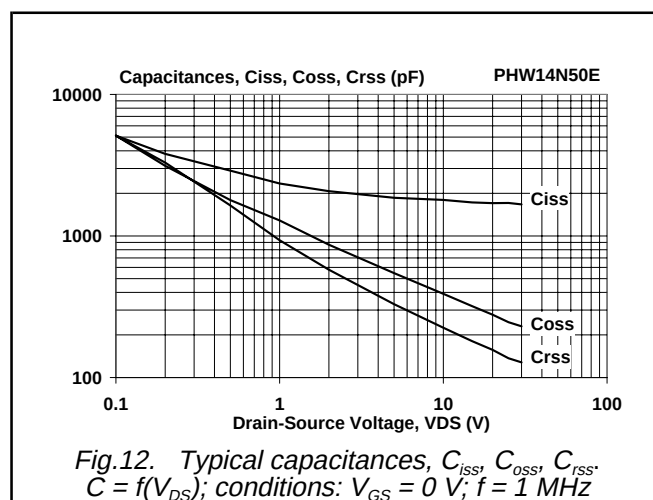
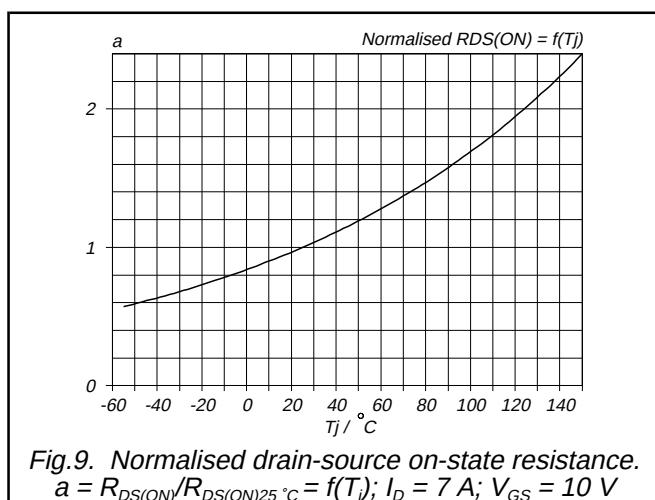
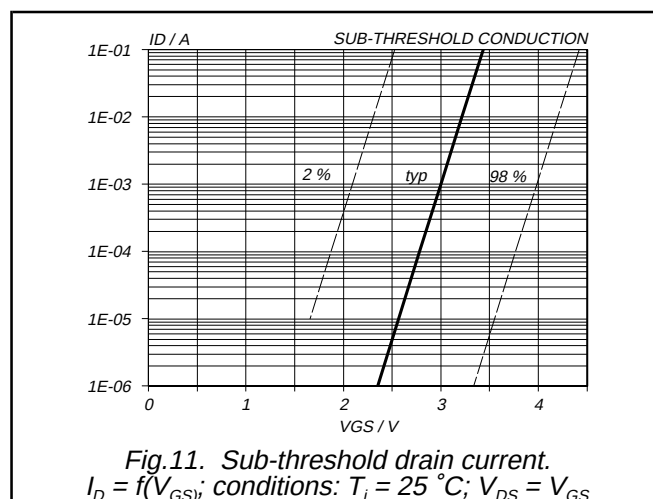
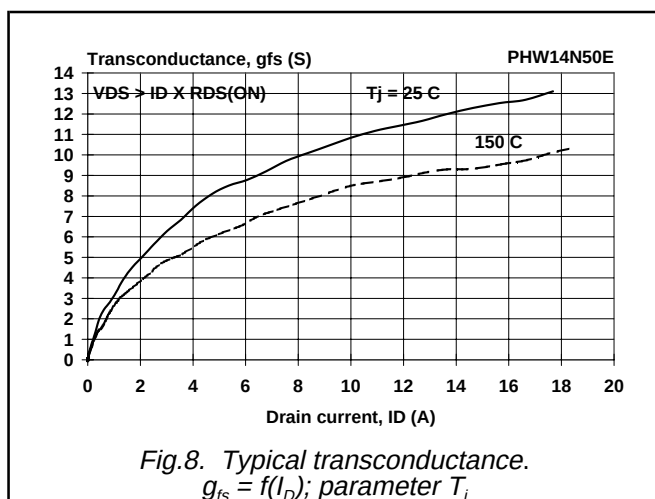
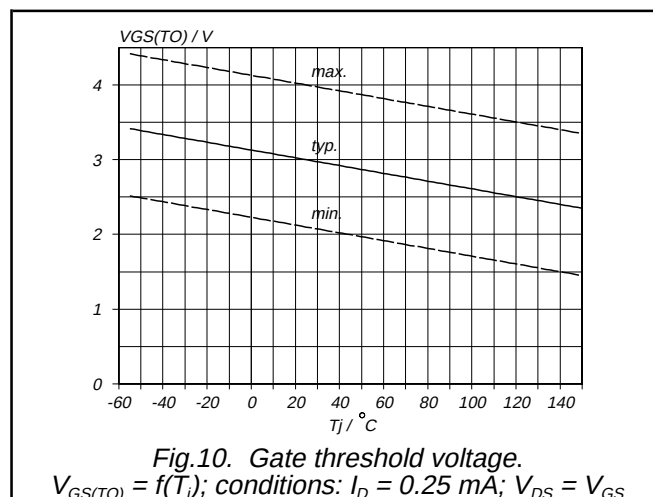
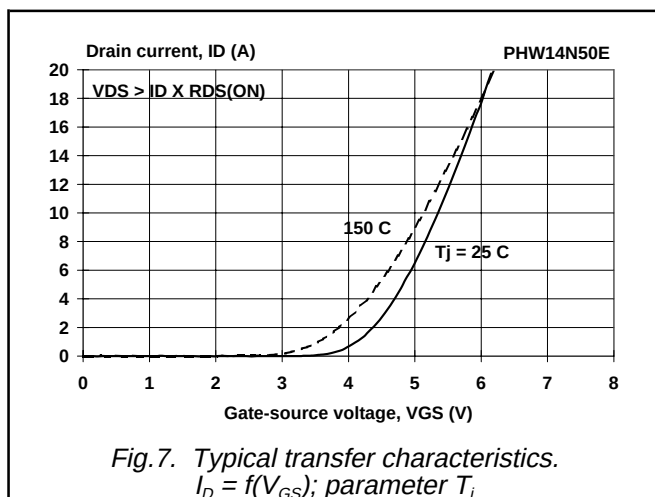
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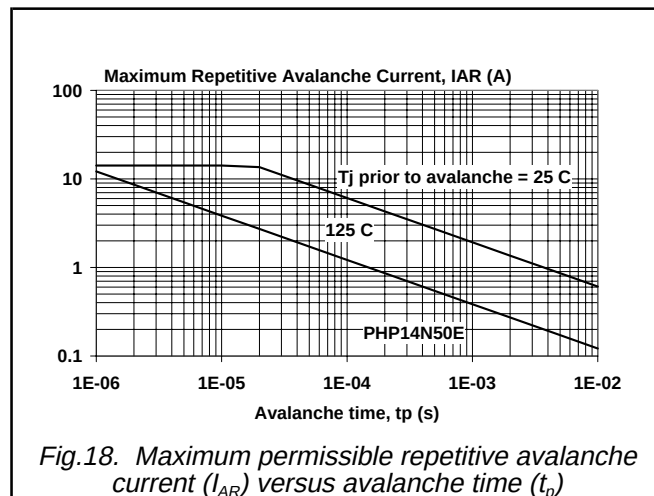
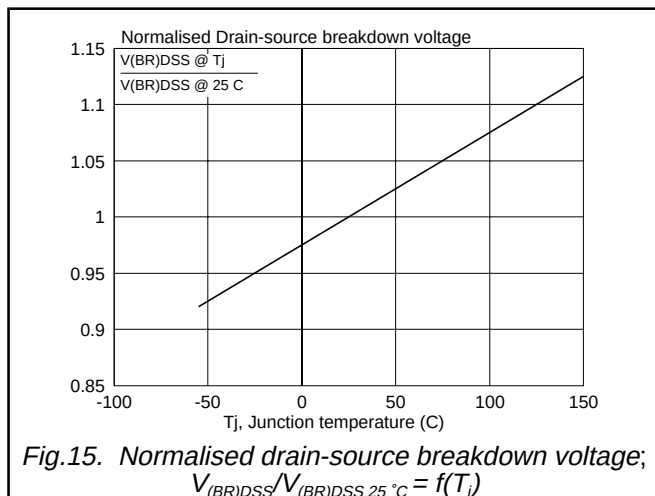
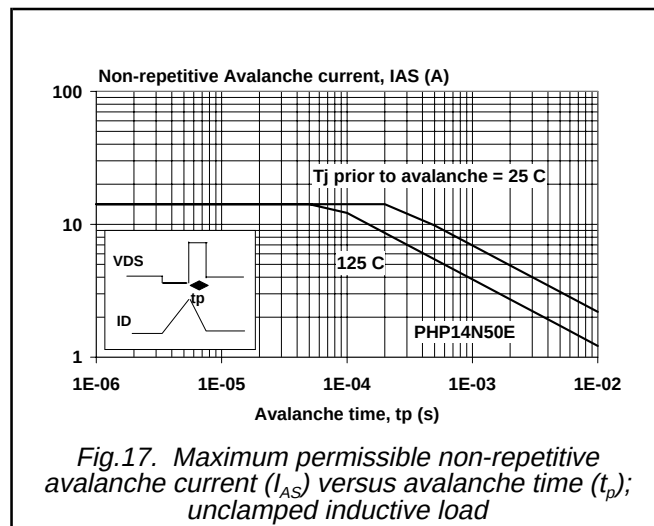
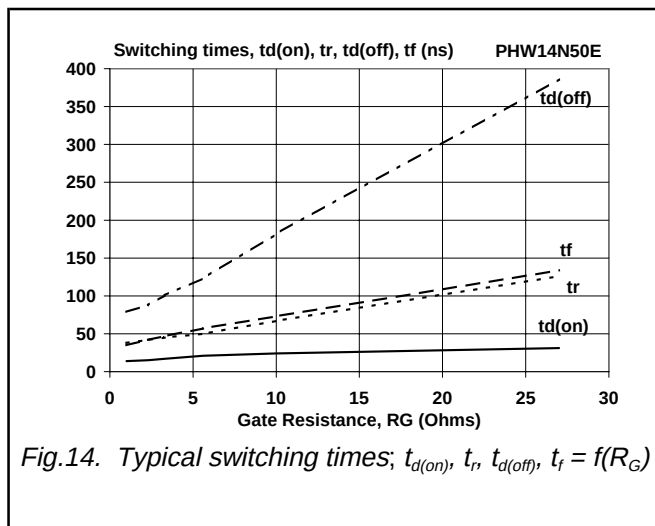
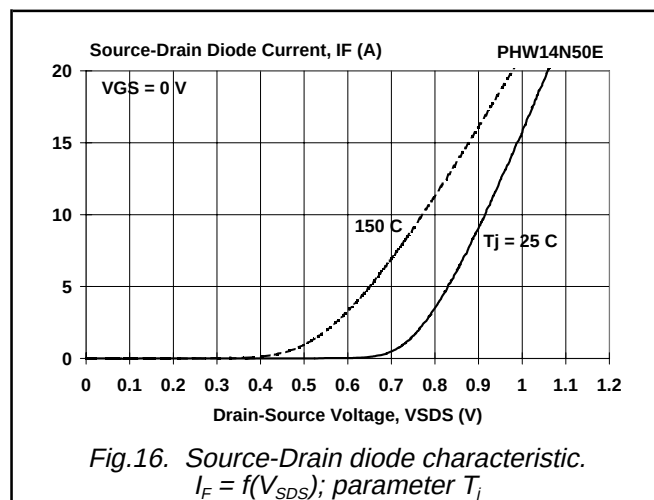
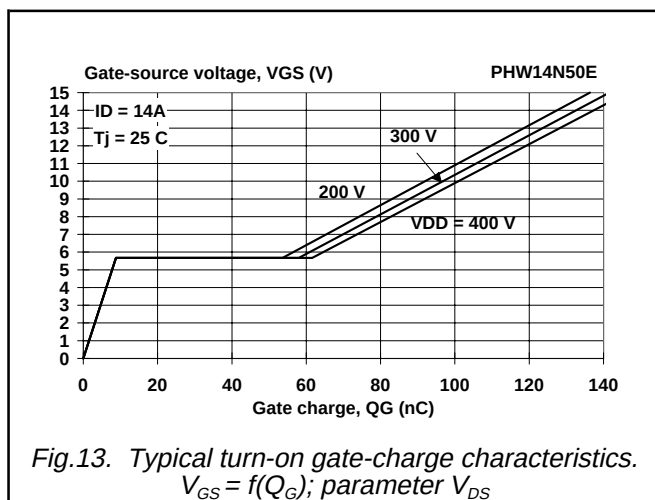
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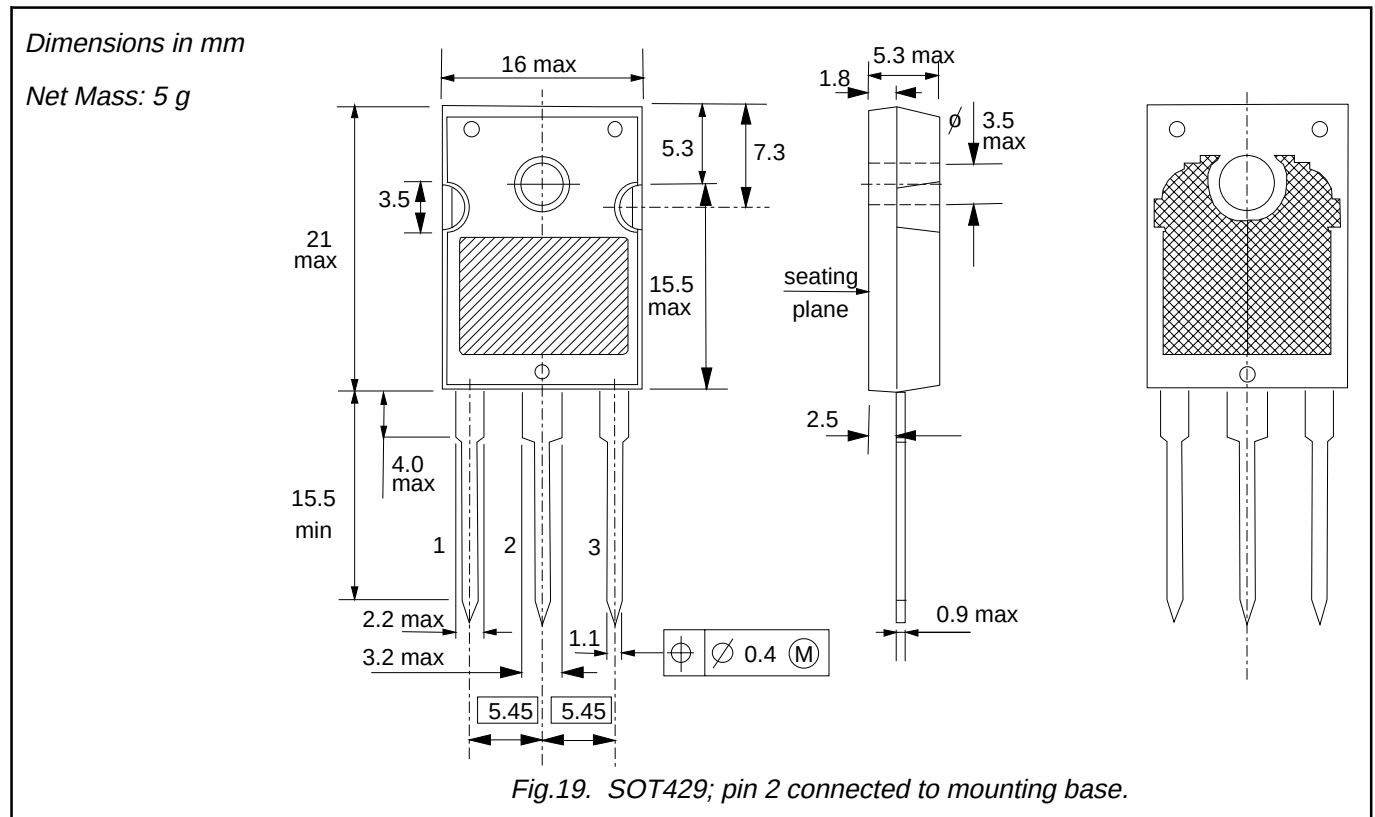


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MECHANICAL DATA



Notes

1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
2. Refer to mounting instructions for SOT429 envelope.
3. Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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